Kingbright

**7.6mmX7.6mm SUPER FLUX LED LAMP**

Part Number: WP7676CSEC/E Hyper Red

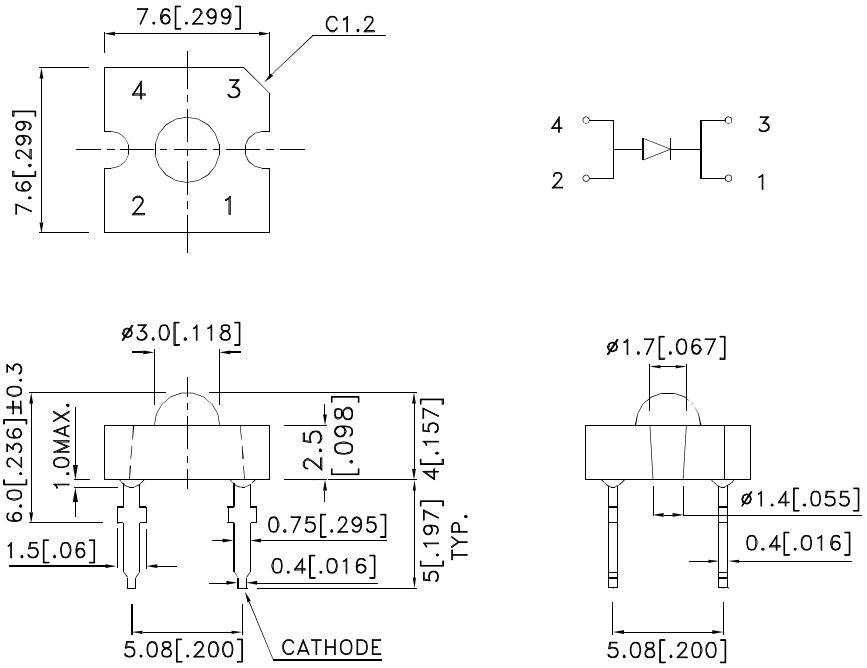
## Features

- Super flux output.
- Design for high current operation.
- Outstanding material efficiency.
- Reliable and rugged.
- RoHS compliant.

## Description

The Hyper Red source color devices are made with Al-GaInP on GaAs substrate Light Emitting Diode.

## Package Dimensions




Notes:
1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.25(0.01") unless otherwise noted.
3. Lead spacing is measured where the leads emerge from the package.
4. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

## Selection Guide

| Part No. | Dice | Lens Type | Iv (mcd) [2] @ 20mA * | | Φv (mlm) [2] @ 20mA | Viewing Angle [1] |
|---|---|---|---|---|---|---|
| | | | Min. | Typ. | Typ. | 2θ1/2 |
| WP7676CSEC/E | Hyper Red (AlGaInP) | Water Clear | 480 | 800 | 900 | 70° |

Notes:
1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity/ luminous Flux: +/-15%.*LEDs are binned according to their Luminous intensity.
3. Drive current between 10mA and 30mA are recommended for long term performance.
4. Operation at current below 10mA is not recommended.

## Electrical / Optical Characteristics at TA=25°C

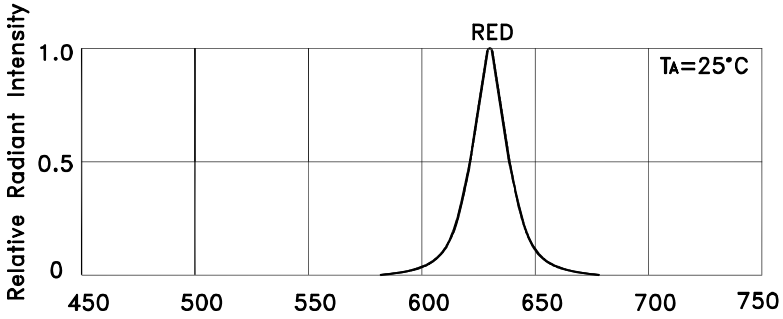
| Symbol | Parameter | Device | Typ. | Max. | Units | Test Conditions |
|---|---|---|---|---|---|---|
| λpeak | Peak Wavelength | Hyper Red | 630 | | nm | $I_F$=20mA |
| λD [1] | Dominant Wavelength | Hyper Red | 621 | | nm | $I_F$=20mA |
| Δλ1/2 | Spectral Line Half-width | Hyper Red | 20 | | nm | $I_F$=20mA |
| C | Capacitance | Hyper Red | 25 | | pF | $V_F$=0V;f=1MHz |
| $V_F$ [2] | Forward Voltage | Hyper Red | 2 | 2.5 | V | $I_F$=20mA |
| $I_R$ | Reverse Current | Hyper Red | | 10 | uA | $V_R$ = 5V |

Notes:
1.Wavelength: +/-1nm.
2. Forward Voltage: +/-0.1V.

## Absolute Maximum Ratings at TA=25°C

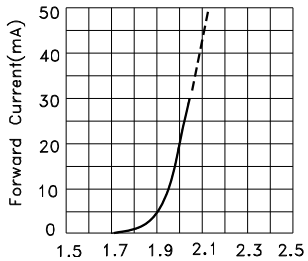
| Parameter | Hyper Red | Units |
|---|---|---|
| Power dissipation | 75 | mW |
| DC Forward Current | 30 | mA |
| Peak Forward Current [1] | 195 | mA |
| Reverse Voltage | 5 | V |
| Operating/Storage Temperature | -40°C To +85°C | |
| Lead Solder Temperature [2] | 260°C For 3 Seconds | |
| Lead Solder Temperature [3] | 260°C For 5 Seconds | |

Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. 2mm below package base.
3. 5mm below package base.

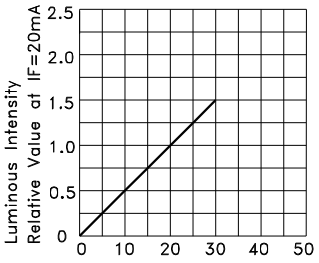


RELATIVE INTENSITY Vs. WAVELENGTH

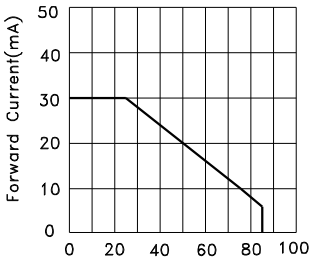
**Hyper Red** **WP7676CSEC/E**



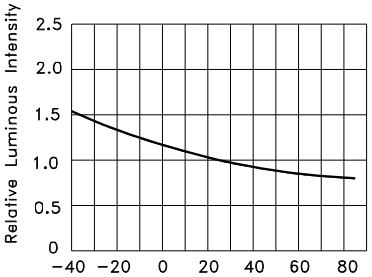
FORWARD CURRENT Vs.
FORWARD VOLTAGE



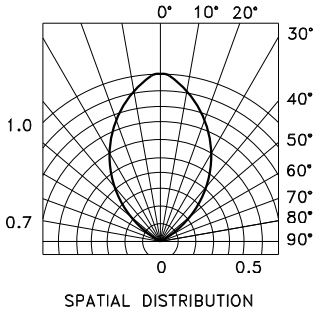
LUMINOUS INTENSITY Vs.
FORWARD CURRENT



FORWARD CURRENT
DERATING CURVE

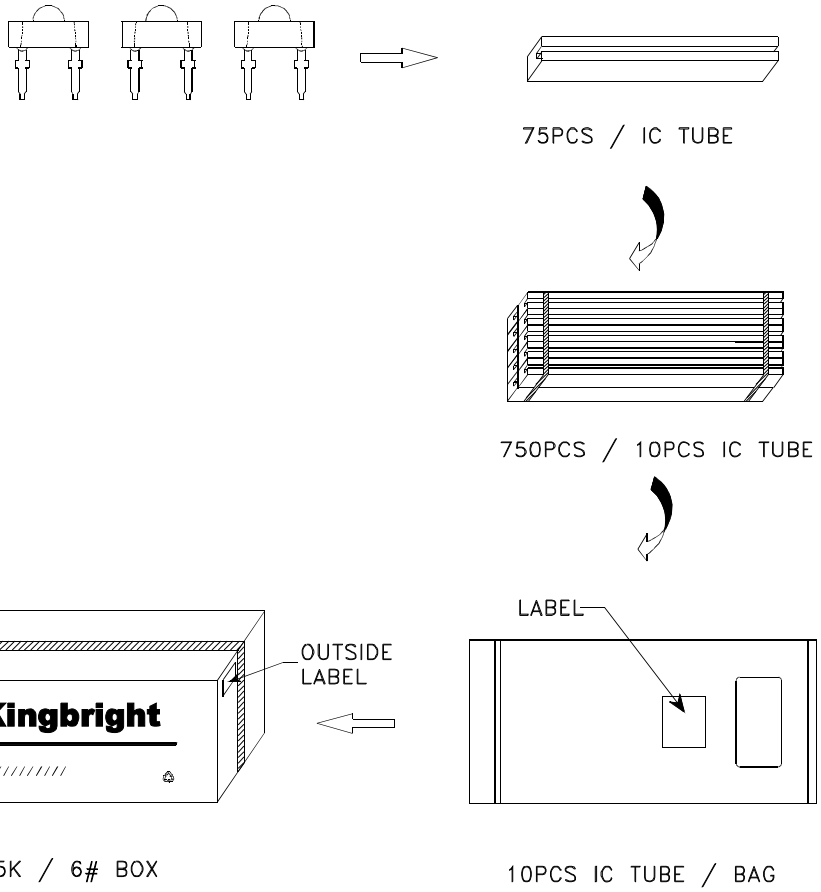


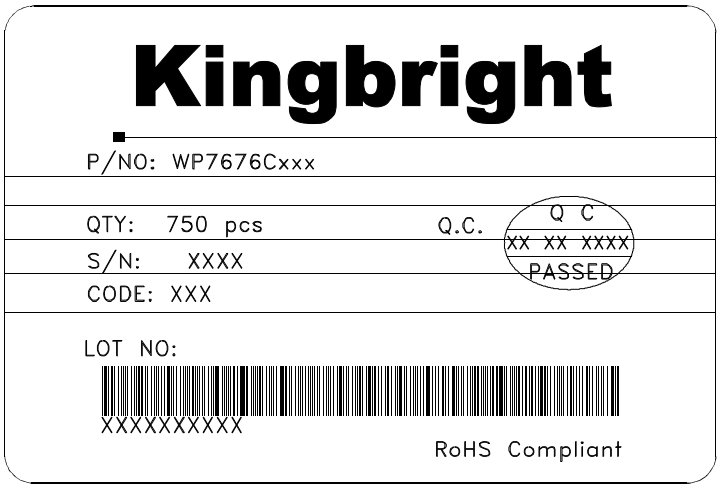
LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE



SPATIAL DISTRIBUTION

**PACKING & LABEL SPECIFICATIONS** **WP7676CSEC/E**



## PRECAUTIONS

1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures. (Fig. 1)

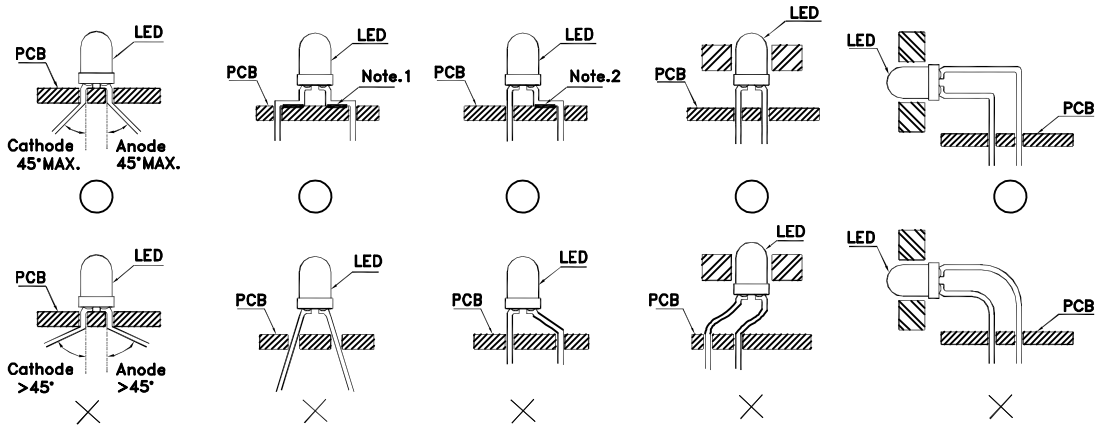



Fig.1

"○" Correct mounting method "×" Incorrect mounting method

2. When soldering wire to the LED, use individual heat-shrink tubing to insulate the exposed leads to prevent accidental contact short-circuit. (Fig.2)

3. Use stand-offs (Fig.3) or spacers (Fig.4) to securely position the LED above the PCB.

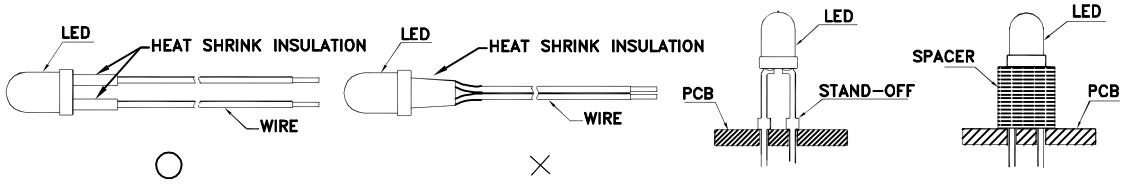



Fig. 2 Fig. 3 Fig. 4

4. Maintain a minimum of 2mm clearance between the base of the LED lens and the first lead bend. (Fig. 5 and 6)
5. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead forming once the component has been mounted onto the PCB. (Fig. 7)

6. Do not bend the leads more than twice. (Fig. 8)

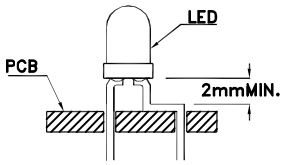


Fig. 5

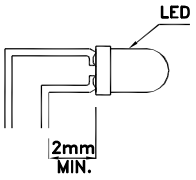


Fig. 6

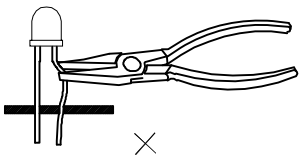


Fig. 7

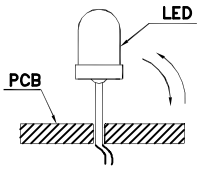
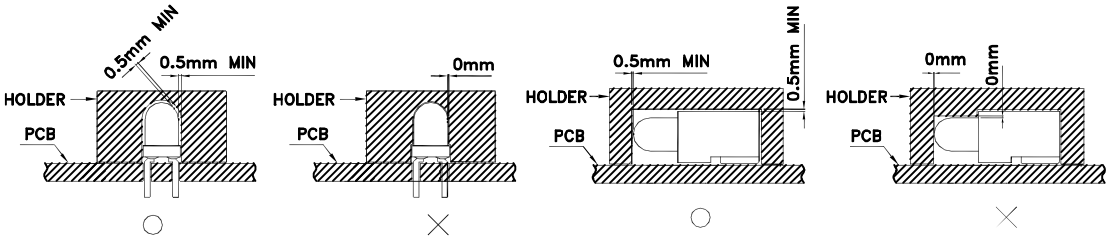
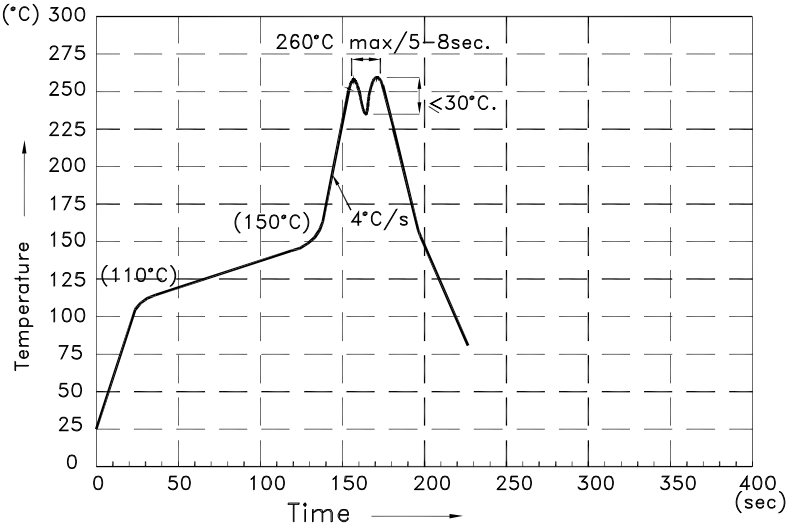


Fig. 8

7. During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering.




8. The tip of the soldering iron should never touch the lens epoxy.
9. Through-hole LEDs are incompatible with reflow soldering.
10. If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.
11. Recommended Wave Soldering Profile for Kingbright Thru-Hole Products




NOTES:

1.Recommend the wave temperature 245°C~260°C.The maximum soldering temperature should be less than 260°C.

2.Do not apply stress on epoxy resins when temperature is over 85°C.

3.The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).

4.During wave soldering, the PCB top-surface temperature should be kept below 105°C.

5.No more than once.

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